

**Tool Pressure Rules**

**Failure to follow these guidelines will not only crush your sample but can also destroy chamber components and the bonding fixture!!**

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| **Sample Size** | **Maximum Tool Pressure (mbar)** |
| 10 x 10 mm2 | 225 |
| 1/4 of 2" Wafer | 1000 |
| 2" Wafer | 1800 |
| 3" Wafer | 3600 |
| 4" Wafer | 5500 |
| 5 - 8" Wafer | 7000 |